## Data Sheet

## FEATURES

128-position
End-to-end resistance $\mathbf{5} \mathbf{k} \Omega, 10 \mathrm{k} \Omega, 50 \mathrm{k} \Omega, 100 \mathrm{k} \Omega$
Ultracompact SC70-6 ( $2 \mathrm{~mm} \times 2.1 \mathrm{~mm}$ ) package
$I^{2} C^{\oplus}$ compatible interface
Full read/write of wiper register
Power-on preset to midscale
Single supply 2.7 V to 5.5 V
Rheostat mode temperature coefficient: $45 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$
Low power, $\mathrm{I}_{\mathrm{DD}}=0.9 \mu \mathrm{~A}$ at 3.3 V typical
Wide operating temperature $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

## APPLICATIONS

Mechanical potentiometer replacement in new designs
Transducer adjustment of pressure, temperature, position,
chemical, and optical sensors
RF amplifier biasing
Automotive electronics adjustment
Gain control and offset adjustment

## GENERAL OVERVIEW

The AD5246 provides a compact $2 \mathrm{~mm} \times 2.1 \mathrm{~mm}$ packaged solution for 128 -position adjustment applications. This device performs the same electronic adjustment function as a variable resistor. Available in four different end-to-end resistance values ( $5 \mathrm{k} \Omega, 10 \mathrm{k} \Omega, 50 \mathrm{k} \Omega, 100 \mathrm{k} \Omega$ ), these low temperature coefficient devices are ideal for high accuracy and stability variable resistance adjustments.

The wiper settings are controllable through the $\mathrm{I}^{2} \mathrm{C}$ compatible digital interface, which can also be used to read back the present wiper register control word. The resistance between the wiper and either end point of the fixed resistor varies linearly with respect to the digital code transferred into the RDAC ${ }^{1}$ latch.

Operating from a 2.7 V to 5.5 V power supply and consuming $0.9 \mu \mathrm{~A}(3.3 \mathrm{~V})$ allows for usage in portable battery-operated applications.
${ }^{1}$ The terms digital potentiometer, VR, and RDAC are used interchangeably in this document.

Rev. C
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FUNCTIONAL BLOCK DIAGRAM


Figure 1.

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## SPECIFICATIONS

## ELECTRICAL CHARACTERISTICS— $\mathbf{5} \mathbf{k} \Omega$ VERSION

$\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 10 \%$ or $3 \mathrm{~V} \pm 10 \% ; \mathrm{V}_{\mathrm{A}}=+\mathrm{V}_{\mathrm{DD}} ;-40^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<+125^{\circ} \mathrm{C}$, unless otherwise noted.
Table 1.

| Parameter | Symbol | Conditions | Min | Typ ${ }^{1}$ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS—RHEOSTAT MODE <br> Resistor Differential Nonlinearity ${ }^{2}$ <br> Resistor Integral Nonlinearity ${ }^{2}$ <br> Nominal Resistor Tolerance ${ }^{3}$ <br> Resistance Temperature Coefficient <br> Rwb | R-DNL <br> R-INL <br> $\Delta \mathrm{R}_{\mathrm{AB}}$ <br> $\left(\Delta R_{A B} / R_{A B}\right) / \Delta T$ <br> Rws | Rwb <br> Rwb <br> $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ <br> Wiper $=$ no connect <br> Code $=0 \times 00, V_{D D}=5 \mathrm{~V}$ <br> Code $=0 \times 00, V_{D D}=2.7 \mathrm{~V}$ | $\begin{aligned} & -1.5 \\ & -4 \\ & -30 \end{aligned}$ | $\begin{aligned} & \pm 0.1 \\ & \pm 0.75 \\ & \\ & 45 \\ & 75 \\ & 150 \\ & \hline \end{aligned}$ | $\begin{aligned} & +1.5 \\ & +4 \\ & +30 \\ & 150 \\ & 400 \\ & \hline \end{aligned}$ | LSB <br> LSB <br> \% <br> $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ <br> $\Omega$ <br> $\Omega$ |
| RESISTOR TERMINALS <br> Voltage Range ${ }^{4}$ <br> Capacitance ${ }^{5}$ B <br> Capacitance ${ }^{5}$ W <br> Common-Mode Leakage | $\begin{aligned} & \mathrm{V}_{B, W} \\ & \mathrm{C}_{\mathrm{B}} \\ & \mathrm{C}_{\mathrm{W}} \\ & \mathrm{I}_{\mathrm{CM}} \end{aligned}$ | $\begin{aligned} & f=1 \mathrm{MHz} \text {, measured to GND, code }=0 \times 40 \\ & \mathrm{f}=1 \mathrm{MHz} \text {, measured to GND, code }=0 \times 40 \end{aligned}$ | GND | $\begin{aligned} & 45 \\ & 60 \\ & 1 \end{aligned}$ | $V_{D D}$ | V <br> pF <br> pF <br> nA |
| DIGITAL INPUTS AND OUTPUTS <br> Input Logic High <br> Input Logic Low <br> Input Logic High <br> Input Logic Low <br> Input Current <br> Input Capacitance ${ }^{5}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{IH}} \\ & \mathrm{~V}_{\mathrm{IL}} \\ & \mathrm{~V}_{\mathrm{H}} \\ & \mathrm{~V}_{\mathrm{IL}} \\ & \mathrm{IILL} \\ & \mathrm{C}_{\mathrm{IL}} \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{DD}}=3 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{DD}}=3 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \text { or } 5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 2.4 \\ & 2.1 \end{aligned}$ | $5$ | $\begin{aligned} & 0.8 \\ & 0.6 \\ & \pm 1 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \mathrm{pF} \end{aligned}$ |
| POWER SUPPLIES <br> Power Supply Range <br> Supply Current <br> Power Dissipation ${ }^{6}$ <br> Power Supply Sensitivity | Vddrange ID <br> PDISS PSSR | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=5.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{H}}=\mathrm{V}_{\mathrm{DD}} \text { or } \mathrm{V}_{\mathrm{IL}}=\mathrm{GND} \\ & \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V} ; \mathrm{V}_{\mathrm{H}}=\mathrm{V}_{\mathrm{DD}} \text { or } \mathrm{V}_{\mathrm{LL}}=\mathrm{GND} \\ & \mathrm{~V}_{\mathrm{DD}}=3.3 \mathrm{~V} ; \mathrm{V}_{\mathrm{H}}=\mathrm{V}_{\mathrm{DD}} \text { or } \mathrm{V}_{\mathrm{L}}=\mathrm{GND} \\ & \mathrm{~V}_{\mathrm{H}}=5 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{IL}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%, \text { code }=\text { midscale } \end{aligned}$ | 2.7 | 3 <br> 2.5 <br> 0.9 $\pm 0.01$ | $\begin{aligned} & 5.5 \\ & 7 \\ & 5.2 \\ & 2 \\ & 40 \\ & \pm 0.025 \end{aligned}$ | V $\mu \mathrm{A}$ $\mu \mathrm{A}$ $\mu \mathrm{A}$ $\mu \mathrm{W}$ \%/\% |
| DYNAMIC CHARACTERISTICS ${ }^{5,7}$ <br> Bandwidth -3 dB <br> Total Harmonic Distortion <br> $\mathrm{V}_{\mathrm{w}}$ Settling Time <br> Resistor Noise Voltage Density | BW_5K <br> THDw <br> ts <br> $\mathrm{e}_{\mathrm{N} \text { _wb }}$ | $\begin{aligned} & \mathrm{R}_{A B}=5 \mathrm{k} \Omega, \text { code }=0 \times 40 \\ & \mathrm{~V}_{\mathrm{A}}=1 \mathrm{Vrms}, \mathrm{~V}_{\mathrm{B}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{~V}_{\mathrm{A}}=5 \mathrm{~V}, \pm 1 \mathrm{LSB} \text { error band } \\ & \mathrm{R}_{\mathrm{WB}}=2.5 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{S}}=0 \Omega \end{aligned}$ |  | $\begin{aligned} & 1.2 \\ & 0.05 \\ & 1 \\ & 6 \end{aligned}$ |  | MHz <br> \% <br> $\mu \mathrm{s}$ <br> $\mathrm{nV} / \sqrt{ } \mathrm{Hz}$ |

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## ELECTRICAL CHARACTERISTICS— $\mathbf{1 0} \mathbf{~ k} \Omega \mathbf{5 0} \mathbf{~ k} \Omega, 100 \mathbf{k} \Omega$ VERSIONS

$\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 10 \%$ or $3 \mathrm{~V} \pm 10 \% ; \mathrm{V}_{\mathrm{A}}=\mathrm{V}_{\mathrm{DD}} ;-40^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<+125^{\circ} \mathrm{C}$, unless otherwise noted.
Table 2.

| Parameter | Symbol | Conditions | Min | Typ ${ }^{1}$ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS, RHEOSTAT MODE <br> Resistor Differential Nonlinearity ${ }^{2}$ Resistor Integral Nonlinearity ${ }^{2}$ Nominal Resistor Tolerance ${ }^{3}$ Resistance Temperature Coefficient Rwb | R-DNL <br> R-INL <br> $\Delta \mathrm{R}_{\mathrm{AB}}$ <br> $\left(\Delta R_{A B} / R_{A B}\right) / \Delta T$ <br> Rws | Rwb, $\mathrm{V}_{\mathrm{A}}=$ no connect <br> $\mathrm{R}_{\mathrm{WB}}, \mathrm{V}_{\mathrm{A}}=$ no connect <br> $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ <br> Wiper $=$ no connect <br> Code $=0 \times 00, V_{D D}=5 \mathrm{~V}$ <br> Code $=0 \times 00, V_{D D}=2.7 \mathrm{~V}$ | $\begin{aligned} & -1 \\ & -2 \\ & -20 \end{aligned}$ | $\begin{aligned} & \pm 0.1 \\ & \pm 0.25 \\ & \\ & 45 \\ & 75 \\ & 150 \end{aligned}$ | $\begin{aligned} & +1 \\ & +2 \\ & +20 \\ & 150 \\ & 400 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \\ & \% \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \Omega \\ & \Omega \end{aligned}$ |
| RESISTOR TERMINALS <br> Voltage Range ${ }^{4}$ <br> Capacitance ${ }^{5}$ B <br> Capacitance ${ }^{5}$ W Common-Mode Leakage | $\begin{aligned} & \mathrm{V}_{\mathrm{B}, \mathrm{~W}} \\ & \mathrm{C}_{\mathrm{B}} \\ & \mathrm{C}_{\mathrm{W}} \\ & \mathrm{I}_{\mathrm{CM}} \\ & \hline \end{aligned}$ | $\mathrm{f}=1 \mathrm{MHz}$, measured to GND, code $=0 \times 40$ <br> $\mathrm{f}=1 \mathrm{MHz}$, measured to $G N D$, code $=0 \times 40$ | GND | $\begin{aligned} & 45 \\ & 60 \\ & 1 \end{aligned}$ | VDD | V <br> pF <br> pF <br> nA |
| DIGITAL INPUTS AND OUTPUTS <br> Input Logic High <br> Input Logic Low <br> Input Logic High <br> Input Logic Low <br> Input Current <br> Input Capacitance ${ }^{5}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{IH}} \\ & \mathrm{~V}_{\mathrm{IL}} \\ & \mathrm{~V}_{\mathrm{HH}} \\ & \mathrm{~V}_{\mathrm{IL}} \\ & \mathrm{IILL}^{\mathrm{C}_{\mathrm{IL}}} \end{aligned}$ | $\begin{aligned} & V_{D D}=5 \mathrm{~V} \\ & V_{D D}=5 \mathrm{~V} \\ & V_{D D}=3 \mathrm{~V} \\ & V_{D D}=3 \mathrm{~V} \\ & V_{I N}=0 \mathrm{~V} \text { or } 5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 2.4 \\ & 2.1 \end{aligned}$ | $5$ | $\begin{aligned} & 0.8 \\ & 0.6 \\ & \pm 1 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \end{aligned}$ $\mathrm{pF}$ |
| POWER SUPPLIES <br> Power Supply Range Supply Current <br> Power Dissipation ${ }^{6}$ Power Supply Sensitivity | Vddrange ldo <br> PDISS PSSR | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=5.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{H}}=\mathrm{V}_{\mathrm{DD}} \text { or } \mathrm{V}_{\mathrm{L}}=\mathrm{GND} \\ & \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V} ; \mathrm{V}_{\mathrm{H}}=\mathrm{V}_{\mathrm{DD}} \text { or } \mathrm{V}_{\mathrm{LL}}=\mathrm{GND} \\ & \mathrm{~V}_{\mathrm{DD}}=3.3 \mathrm{~V} ; \mathrm{V}_{H H}=\mathrm{V}_{\mathrm{DD}} \text { or } \mathrm{V}_{\mathrm{L}}=\mathrm{GND} \\ & \mathrm{~V}_{\mathrm{H}}=5 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{LL}}=0 \mathrm{~V}, \mathrm{~V} \text { VD }=5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V} \pm 10 \%, \text { code }=\text { midscale } \end{aligned}$ | 2.7 | 3 <br> 2.5 <br> 0.9 $\pm 0.01$ | 5.5 7 5.2 2 40 $\pm 0.02$ | V $\mu \mathrm{A}$ $\mu \mathrm{A}$ $\mu \mathrm{A}$ $\mu \mathrm{W}$ \%/\% |
| DYNAMIC CHARACTERISTICS ${ }^{5,7}$ <br> Bandwidth -3 dB <br> Total Harmonic Distortion $V_{w}$ Settling Time ( $10 \mathrm{k} \Omega / 50 \mathrm{k} \Omega / 100 \mathrm{k} \Omega$ ) Resistor Noise Voltage Density | BW <br> THDw <br> ts <br> $\mathrm{e}_{\mathrm{N}, \mathrm{wb}}$ | $\begin{aligned} & \mathrm{R}_{A B}=10 \mathrm{k} \Omega / 50 \mathrm{k} \Omega / 100 \mathrm{k} \Omega \text {, code }=0 \times 40 \\ & \mathrm{~V}_{A}=1 \mathrm{~V} \mathrm{rms}, \mathrm{f}=1 \mathrm{kHz}, \mathrm{R}_{A B}=10 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{A}}=5 \mathrm{~V} \pm 1 \mathrm{LSB} \text { error band } \\ & \mathrm{R}_{W B}=5 \mathrm{k} \Omega, \mathrm{R}_{S}=0 \end{aligned}$ |  | $\begin{aligned} & 600 / 100 / 40 \\ & 0.05 \\ & 2 \\ & 9 \end{aligned}$ |  | kHz <br> \% <br> $\mu \mathrm{s}$ <br> $\mathrm{nV} / \sqrt{ } \mathrm{Hz}$ |

[^1]
## Data Sheet

## TIMING CHARACTERISTICS

$\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 10 \%$ or $3 \mathrm{~V} \pm 10 \% ; \mathrm{V}_{\mathrm{A}}=\mathrm{V}_{\mathrm{DD}} ;-40^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<+125^{\circ} \mathrm{C}$, unless otherwise noted.
Table 3.

| Parameter | Symbol | Conditions | Min | Typ ${ }^{1}$ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $1^{2} \mathrm{C}$ INTERFACE TIMING CHARACTERISTICS ${ }^{2,3,4}$ |  |  |  |  |  |  |
| SCL Clock Frequency | fscl |  |  |  | 400 | kHz |
| $\mathrm{t}_{\text {BuF }}$ Bus Free Time Between STOP and START | $\mathrm{t}_{1}$ |  | 1.3 |  |  | $\mu \mathrm{s}$ |
| $\mathrm{thD}_{\text {STA }}$ Hold Time (Repeated START) | $\mathrm{t}_{2}$ | After this period, the first clock pulse is generated | 0.6 |  |  | $\mu \mathrm{s}$ |
| tıow Low Period of SCL Clock | $\mathrm{t}_{3}$ |  | 1.3 |  |  | $\mu \mathrm{s}$ |
| $\mathrm{t}_{\text {HIGH }}$ High Period of SCL Clock | $\mathrm{t}_{4}$ |  | 0.6 |  | 50 | $\mu \mathrm{S}$ |
| tsu:sta Setup Time for Repeated START Condition | $\mathrm{t}_{5}$ |  | 0.6 |  |  | $\mu \mathrm{s}$ |
| thd; Dat Data Hold Time | $\mathrm{t}_{6}$ |  |  |  | 0.9 | $\mu \mathrm{s}$ |
| $\mathrm{tsu} ;$ DAt $^{\text {Data Setup Time }}$ | $\mathrm{t}_{7}$ |  | 100 |  |  | ns |
| $\mathrm{t}_{\mathrm{F}}$ Fall Time of Both SDA and SCL Signals | $\mathrm{t}_{8}$ |  |  |  | 300 | ns |
| $\mathrm{t}_{\mathrm{R}}$ Rise Time of Both SDA and SCL Signals | $\mathrm{t}_{9}$ |  |  |  | 300 | ns |
| tsu;sto Setup Time for STOP Condition $^{\text {a }}$ | $\mathrm{t}_{10}$ |  | 0.6 |  |  | $\mu \mathrm{s}$ |

${ }^{1}$ Typical specifications represent average readings at $25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$.
${ }^{2}$ Guaranteed by design; not subject to production test.
${ }^{3}$ See timing diagrams (Figure 26, Figure 27, and Figure 28) for locations of measured values.
${ }^{4}$ Specifications apply to all parts.

## ABSOLUTE MAXIMUM RATINGS

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

Table 4.

| Parameter | Value |
| :---: | :---: |
| VDD to GND | -0.3 V to +7 V |
| $\mathrm{V}_{\mathrm{A}}, \mathrm{V}_{\mathrm{w}}$ to GND | $V_{D D}$ |
| Terminal Current, $\mathrm{A}-\mathrm{B}, \mathrm{A}-\mathrm{W}, \mathrm{B}-\mathrm{W}$ |  |
| Pulsed ${ }^{1}$ | $\pm 20 \mathrm{~mA}$ |
| Continuous | $\pm 5 \mathrm{~mA}$ |
| Digital Inputs and Output Voltage to GND | 0 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Operating Temperature Range | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Maximum Junction Temperature ( $\mathrm{T}_{\text {max }}$ ) | $150^{\circ} \mathrm{C}$ |
| Storage Temperature | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 10 sec ) | $300^{\circ} \mathrm{C}$ |
| Thermal Resistance ${ }^{2} \theta_{\mathrm{JA}}$ : SC70-6 | $340^{\circ} \mathrm{C} / \mathrm{W}$ |

${ }^{1}$ Maximum terminal current is bounded by the maximum current handling of the switches, maximum power dissipation of the package, and maximum applied voltage across any two of the $\mathrm{A}, \mathrm{B}$, and W terminals at a given resistance.
${ }^{2}$ Package power dissipation $=\left(\mathrm{T}_{\mathrm{Jmax}}-\mathrm{T}_{\mathrm{A}}\right) / \theta_{\mathrm{JA}}$.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

AD5246

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Figure 2. Pin Configuration

Table 5. Pin Function Descriptions

| Pin No. | Mnemonic | Description |
| :--- | :--- | :--- |
| 1 | VDD | Positive Power Supply. |
| 2 | GND | Digital Ground. |
| 3 | SCL | Serial Clock Input. Positive edge triggered. |
| 4 | SDA | Serial Data Input/Output. |
| 5 | W | W Terminal. |
| 6 | B | B Terminal. |

## TYPICAL PERFORMANCE CHARACTERISTICS



Figure 3. R-INL vs. Code vs. Supply Voltages


Figure 4. R-DNL vs. Code vs. Supply Voltages


Figure 5. R-INL vs. Code vs. Temperature


Figure 6. R-DNL vs. Code vs. Temperature


Figure 7. Full-Scale Error vs. Temperature


Figure 8. Zero-Scale Error vs. Temperature


Figure 9. Supply Current vs. Temperature


Figure 10. Rheostat Mode Tempco $\Delta R_{w B} / \Delta T$ vs. Code


Figure 11. Gain vs. Frequency vs. Code, $R_{A B}=5 \mathrm{k} \Omega$


Figure 12. Gain vs. Frequency vs. Code, $R_{A B}=10 \mathrm{k} \Omega$


Figure 13. Gain vs. Frequency vs. Code, $R_{A B}=50 \mathrm{k} \Omega$


Figure 14. Gain vs. Frequency vs. Code, $R_{A B}=100 \mathrm{k} \Omega$


Figure 15. $-3 d B$ Bandwidth @ Code $=0 \times 80$


Figure 16. $I_{D D}$ vs. Frequency


Figure 17. RwB vs. VBIAS vs. VDD


Figure 18. Digital Feedthrough


Figure 19. Midscale Glitch, Code $0 \times 40$ to $0 \times 3 F$


Figure 20. Large Signal Settling Time

## TEST CIRCUITS

Figure 21 to Figure 25 define the test conditions used in the product Specification tables.


Figure 21. Test Circuit for Resistor Position Nonlinearity Error (Rheostat Operation; R-INL, R-DNL)


Figure 22. Test Circuit for Power Supply Sensitivity (PSS, PSSR)


Figure 23. Test Circuit for Gain vs. Frequency

## I'C INTERFACE

Table 6. Write Mode

| S | 0 | 1 | 0 | 1 | 1 | 1 | 0 | $\overline{\text { W }}$ | A | X | D6 | D5 | D4 | D3 | D2 | D1 | D0 | A | P |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Slave Address Byte |  |  |  |  |  |  |  |  | Data Byte |  |  |  |  |  |  |  |  |  |

Table 7. Read Mode

| S | 0 | 1 | 0 | 1 | 1 | 1 | 0 | R | A | 0 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | A | P |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Slave Address Byte |  |  |  |  |  |  |  |  | Data Byte |  |  |  |  |  |  |  |  |  |

$S=$ Start Condition.
$\mathrm{P}=$ Stop Condition.
A = Acknowledge.
X = Don't Care.
$\bar{W}=$ Write.
$\mathrm{R}=$ Read.
D6, D5, D4, D3, D2, D1, D0 = Data Bits.


Figure 26. $I^{2}$ C Interface, Detailed Timing Diagram


Figure 27. Writing to the RDAC Register


Figure 28. Reading from the RDAC Register

## OPERATION

The AD5246 is a 128-position, digitally controlled variable resistor (VR) device.

## PROGRAMMING THE VARIABLE RESISTOR Rheostat Operation

The nominal resistance of the RDAC between Terminal A and Terminal B is available in $5 \mathrm{k} \Omega, 10 \mathrm{k} \Omega, 50 \mathrm{k} \Omega$, and $100 \mathrm{k} \Omega$. The final two or three digits of the part number determine the nominal resistance value, that is, $10 \mathrm{k} \Omega=10,50 \mathrm{k} \Omega=50$. The nominal resistance ( $\mathrm{R}_{\mathrm{AB}}$ ) of the VR has 128 contact points accessed by the wiper terminal. The 7-bit data in the RDAC latch is decoded to select one of the 128 possible settings.

The general equation determining the digitally programmed output resistance between W and B is

$$
\begin{equation*}
R_{W B}(D)=\frac{D}{128} \times R_{A B}+2 \times R_{W} \tag{1}
\end{equation*}
$$

where:
$D$ is the decimal equivalent of the binary code loaded in the 7-bit RDAC register.
$R_{A B}$ is the end-to-end resistance.
$R_{W}$ is the wiper resistance contributed by the on resistance of each internal switch.


Figure 29. AD5246 Equivalent RDAC Circuit

Note that in the zero-scale condition, there is a relatively small finite wiper resistance. Care should be taken to limit the current flow between W and B in this state to a maximum pulse current of no more than 20 mA . Otherwise, degradation or possible destruction of the internal switch contact can occur.

Typical device-to-device matching is process lot dependent and may vary by up to $\pm 30 \%$. Since the resistance element is processed in thin-film technology, the temperature coefficient of $\mathrm{R}_{\mathrm{AB}}$ is only $45 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$.

## $I^{2}$ C COMPATIBLE 2-WIRE SERIAL BUS

The first byte of the AD5246 is a slave address byte (see Table 6 and Table 7). It has a 7 -bit slave address and an $\mathrm{R} / \overline{\mathrm{W}}$ bit. The seven MSBs of the slave address are 0101110 followed by 0 for a write command or 1 to place the device in read mode.

The 2 -wire $\mathrm{I}^{2} \mathrm{C}$ serial bus protocol operates as follows:

1. The master initiates data transfer by establishing a START condition, which is when a high-to-low transition on the SDA line occurs while SCL is high (see Figure 27). The following byte is the slave address byte, which consists of the 7 -bit slave address followed by an $\mathrm{R} / \overline{\mathrm{W}}$ bit (this bit determines whether data will be read from or written to the slave device).

The slave whose address corresponds to the transmitted address responds by pulling the SDA line low during the ninth clock pulse (this is termed the acknowledge bit). At this stage, all other devices on the bus remain idle while the selected device waits for data to be written to or read from its serial register. If the $\mathrm{R} / \overline{\mathrm{W}}$ bit is high, the master reads from the slave device. Conversely, if the $\mathrm{R} / \overline{\mathrm{W}}$ bit is low, the master writes to the slave device.
2. In write mode, after acknowledgement of the slave address byte, the next byte is the data byte. Data is transmitted over the serial bus in sequences of nine clock pulses (eight data bits followed by an acknowledge bit). The transitions on the SDA line must occur during the low period of SCL and remain stable during the high period of SCL (see Table 6).
3. In read mode, after acknowledgment of the slave address byte, data is received over the serial bus in sequences of nine clock pulses (a slight difference from the write mode where eight data bits are followed by an acknowledge bit). Similarly, the transitions on the SDA line must occur during the low period of SCL and remain stable during the high period of SCL (see Figure 28).
4. When all data bits have been read or written, a STOP condition is established by the master. A STOP condition is defined as a low-to-high transition on the SDA line while SCL is high. In write mode, the master pulls the SDA line high during the tenth clock pulse to establish a STOP condition (see Figure 27). In read mode, the master issues a No Acknowledge for the ninth clock pulse (that is, the SDA line remains high). The master then brings the SDA line low before the tenth clock pulse, which goes high to establish a STOP condition (see Figure 28).

A repeated write function gives the user flexibility to update the RDAC output a number of times after addressing the part only once. For example, after the RDAC has acknowledged its slave address in write mode, the RDAC output updates on each successive byte. If different instructions are needed, the write/read mode has to start again with a new slave address and data byte. Similarly, a repeated read function of the RDAC is also allowed.

## LEVEL SHIFTING FOR BIDIRECTIONAL INTERFACE

While most legacy systems may be operated at one voltage, a new component may be optimized at another. When two systems operate the same signal at two different voltages, proper level shifting is needed. For instance, one can use a 1.8 V $\mathrm{E}^{2}$ PROM to interface with a 5 V digital potentiometer. A level shifting scheme is needed to enable a bidirectional communication so that the setting of the digital potentiometer can be stored to and retrieved from the $E^{2}$ PROM. Figure 30 shows one of the implementations. M1 and M2 can be any N channel signal FETs, or if $\mathrm{V}_{\mathrm{DD}}$ falls below $2.5 \mathrm{~V}, \mathrm{M} 1$ and M2 can be low threshold FETs such as the FDV301N.


Figure 30. Level Shifting for Operation at Different Potentials

## ESD PROTECTION

All digital inputs are protected with a series input resistor and parallel Zener ESD structures, as shown in Figure 31. This applies to the digital input pins SDA and SCL.


Figure 31. ESD Protection of Digital Pins

## TERMINAL VOLTAGE OPERATING RANGE

The AD5246 $\mathrm{V}_{\mathrm{DD}}$ and GND power supply defines the boundary conditions for proper 3-terminal digital potentiometer operation. Supply signals present on Terminal B and Terminal W that exceed $V_{D D}$ or GND are clamped by the internal forward biased diodes (see Figure 32).


Figure 32. Maximum Terminal Voltages Set by $V_{D D}$ and GND

## MAXIMUM OPERATING CURRENT

At low code values, the user should be aware that due to low resistance values, the current through the RDAC may exceed the 5 mA limit. In Figure 33, a 5 V supply is placed on the wiper, and the current through Terminal W and Terminal B is plotted with respect to code. A line is also drawn denoting the 5 mA current limit. Note that at low code values (particularly for the $5 \mathrm{k} \Omega$ and $10 \mathrm{k} \Omega$ options), the current level increases significantly. Care should be taken to limit the current flow between W and B in this state to a maximum continuous current of 5 mA and a maximum pulse current of no more than 20 mA . Otherwise, degradation or possible destruction of the internal switch contacts can occur.


Figure 33. Maximum Operating Current

## POWER-UP SEQUENCE

Since the ESD protection diodes limit the voltage compliance at Terminal B and Terminal W (see Figure 32), it is important to power $\mathrm{V}_{\mathrm{DD}} / \mathrm{GND}$ before applying any voltage to Terminal B and Terminal W ; otherwise, the diode is forward biased such that $V_{D D}$ is powered unintentionally and may affect the rest of the user's circuit. The ideal power-up sequence is in the following order: GND, $V_{D D}$, digital inputs, and then $V_{B} / V_{w}$. The relative order of powering $\mathrm{V}_{\mathrm{B}}$ and $\mathrm{V}_{\mathrm{w}}$ and the digital inputs is not important, providing they are powered after $V_{D D} / G N D$.

## LAYOUT AND POWER SUPPLY BYPASSING

It is a good practice to use a compact, minimum lead-length layout design. The leads to the inputs should be as direct as possible with a minimum conductor length. Ground paths should have low resistance and low inductance.

Similarly, it is good practice to bypass the power supplies with quality capacitors for optimum stability. Supply leads to the device should be bypassed with $0.01 \mu \mathrm{~F}$ to $0.1 \mu \mathrm{~F}$ disc or chip ceramic capacitors. Low ESR $1 \mu \mathrm{~F}$ to $10 \mu \mathrm{~F}$ tantalum or electrolytic capacitors should also be applied at the supplies to minimize any transient disturbance and low frequency ripple (see Figure 34). Note that the digital ground should also be joined remotely to the analog ground at one point to minimize the ground bounce.


Figure 34. Power Supply Bypassing

## CONSTANT BIAS TO RETAIN RESISTANCE SETTING

For users who desire nonvolatility but cannot justify the additional cost for the EEMEM, the AD5246 may be considered as a low cost alternative by maintaining a constant bias to retain the wiper setting. The AD5246 was designed specifically with low power in mind, which allows low power consumption even in battery-operated systems. The graph in Figure 35 demonstrates the power consumption from a $3.4 \mathrm{~V} 450 \mathrm{~mA} / \mathrm{hr}$ Li-ion cell phone battery, which is connected to the AD5246.

The measurement over time shows that the device draws approximately $1.3 \mu \mathrm{~A}$ and consumes negligible power. Over a course of 30 days, the battery was depleted by less than $2 \%$, the majority of which is due to the intrinsic leakage current of the battery itself.


Figure 35. Battery Operating Life Depletion

This demonstrates that constantly biasing the pot is not an impractical approach. Most portable devices do not require the removal of batteries for the purpose of charging. Although the resistance setting of the AD5246 will be lost when the battery needs replacement, such events occur rather infrequently, so that this inconvenience is justified by the lower cost and smaller size offered by the AD5246. If and when total power is lost, the user should be provided with a means to adjust the setting accordingly.

## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-203-AB
Figure 36. 6-Lead Thin Shrink Small Outline Transistor Package [SC70] (KS-6)
Dimensions shown in millimeters

## ORDERING GUIDE

| Model ${ }^{1,2}$ | $\mathrm{R}_{\mathrm{AB}}(\mathrm{k} \Omega$ ) | Temperature Range | Package Description | Package Option | Branding |
| :---: | :---: | :---: | :---: | :---: | :---: |
| AD5246BKSZ5-RL7 | 5 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 6-lead SC70 | KS-6 | D93 |
| AD5246BKSZ10-R2 | 10 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 6-lead SC70 | KS-6 | D92 |
| AD5246BKSZ10-RL7 | 10 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 6-lead SC70 | KS-6 | D92 |
| AD5246BKSZ50-RL7 | 50 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 6-lead SC70 | KS-6 | D94 |
| AD5246BKSZ100-R2 | 100 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 6-lead SC70 | KS-6 | D9D |
| AD5246BKSZ100-RL7 <br> EVAL-AD5246DBZ | 100 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 6-lead SC70 <br> Evaluation Board | KS-6 | D9D |

${ }^{1} \mathrm{Z}=$ RoHS Compliant Part.
${ }^{2}$ The evaluation board is shipped with the $10 \mathrm{k} \Omega \mathrm{R}_{A B}$ resistor option; however, the board is compatible with all available resistor value options.


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[^0]:    ${ }^{1}$ Typical specifications represent average readings at $25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$.
    ${ }^{2}$ Resistor position nonlinearity error R-INL is the deviation from an ideal value measured between the maximum resistance and the minimum resistance wiper positions. R-DNL measures the relative step change from ideal between successive tap positions. Parts are guaranteed monotonic.
    ${ }^{3}$ Code $=0 \times 7$ F.
    ${ }^{4}$ Resistor Terminal A and Resistor Terminal W have no limitations on polarity with respect to each other
    ${ }^{5}$ Guaranteed by design; not subject to production test.
    ${ }^{6} P_{\text {DISS }}$ is calculated from ( $l_{D D} \times V_{D D}$ ). CMOS logic level inputs result in minimum power dissipation.
    ${ }^{7} \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}$.

[^1]:    ${ }^{1}$ Typical specifications represent average readings at $25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$.
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    ${ }^{5}$ Guaranteed by design; not subject to production test.
    ${ }^{6} \mathrm{P}_{\text {DISS }}$ is calculated from ( $\mathrm{I}_{\mathrm{DD}} \times \mathrm{V}_{\text {DD }}$ ). CMOS logic level inputs result in minimum power dissipation.
    ${ }^{7}$ All dynamic characteristics use $V_{D D}=5 \mathrm{~V}$.

